#### 502000742 07/25/2012

## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
John Paul Strachan	07/23/2012
Gilberto Medeiros Ribeiro	07/23/2012
Jianhua Yang	07/23/2012
Wei Yi	07/23/2012

#### RECEIVING PARTY DATA

Name:	Hewlett-Packard Development Company, L.P.
Street Address:	11445 Compaq Center Drive West
City:	Houston
State/Country:	TEXAS
Postal Code:	77070

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13557199

#### CORRESPONDENCE DATA

Fax Number: 9707784063 Phone: (541)715-8443

Email: pto.assignments@hp.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

Correspondent Name: Hewlett-Packard Company
Address Line 1: 3404 E. Harmony Road MS 35
Address Line 2: Intellectual Property Administration
Address Line 4: Fort Collins, COLORADO 80528

NAME OF SUBMITTER:

J. Michael Johnson

Total Attachments: 3

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HEWLETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35 Fort Collins, Colorado 80528

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RECORD ID:	82978174
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# ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston,

Texas, (hereinafter HPDC), in furtherance of my/our obli- subsidiaries and affiliates, and do hereby assign and transfer title and interest, including the right of priority, in, to and under entitled:	gations to the Hewlett-Packard Company and its to HPDC, its successors and assigns, the entire right,		
Bipolar Resistive Switch Heat Mitigation			
Filing Date: A	pplication No.:		
held and enjoyed by HPDC, its successors, assigns, nomineer terms for which said Letters Patent respectively may be gram same would have been held and enjoyed by me/us had this as AND I/we hereby covenant that I/we have full right to we have not executed and will not execute any agreement in that I/we will, each time a request is made, and without undue necessary or desirable to perfect the title to said invention(s) Patent, to HPDC, its successors, assigns, nominees or legal HPDC, or to its nominee, all known facts respecting said inventions. C-I-P's, reissue and foreign applications, to made everything possible to aid HPDC, its successors, assign enforce, for its or their own benefit, proper patent protection countries provided the expenses which may be incurred by repaid by HPDC;  AND I/we hereby authorize and request the Commission and any official of any country or countries foreign to the applications as aforesaid, to issue to HPDC, as assignee of Patent for said invention(s) or improvement(s), including any be issued and granted on or as a result of the application afore	ication for said Letters Patent, and any and all Letters which may be granted thereon or therefore; and any int.  In my/our name for Letters Patent in any country, to be sor legal representatives, to the full end of the term or ted, reissued or extended, as fully and entirely as the signment, and transfer not been made; convey the entire interest herein assigned, and that is conflict herewith, and I/we further covenant and agree delay, execute and deliver all such papers as may be or improvement(s), said application and said Letters of the tention(s) or improvement(s), said application and said letters all rightful oaths and declarations, and generally to some interest and invention(s) or improvement(s) in any and all ne/us in lending such cooperation and assistance are used to the entire right, title and interest, any and all Letters and all Letters Patent of the United States which may esaid, in accordance with the terms of this assignment cord to insert the serial number and filing date of said habove as soon as the same shall have been made.		
Q-da S	Date Assignment Signed		
Inventor's Signature	Date Assignment Signed		
John Paul Strachan			
Inventor's Typed Name	Date Application Signed		
44/05	7/23/202		
Inventor's Signature  Gilberto Medeiros Ribeiro	Date Assignment Signed		
Inventor's Typed Name Date Application Signed			

Rev 09/11 (Assignment)

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HEWLETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35

# PATENT APPLICATION

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Sanhua Vana		7/2	23/2012	
Jianhua Yang Inventor's Typed Name		Date Application		
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HEWLETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35

## PATENT APPLICATION

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Fort Collins, Colorado 80528	J	
///	SSIGNMENT OF PATENT APP	
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inventor's Signature		Date Assignment Signed
Wei Yi		07/23/2012
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